INTEGRATED CIRCUITS

DATA SHEET

CBT6820

20-bit bus switch with precharged outputs and Schottky undershoot protection for live insertion

Product specification Supersedes data of 1999 Apr 05





20-bit bus switch with precharged outputs and Schottky undershoot protection for live insertion

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FEATURES

- TTL compatible inputs and outputs
- \bullet 5 Ω switch connection between two port A and port B
- Thin shrink small outline (TSSOP)
- Undershoot protection included to prevent shoot through level changes
- Bias voltage pre-charges the outputs to minimize signal distortion during live insertion
- Latch-up protection exceeds 500 mA per JESD78
- ESD protection exceeds 2000 V HBM per JESD22-A114,
 200 V MM per JESD22-A115 and 1000 V CDM per JESD22-C101

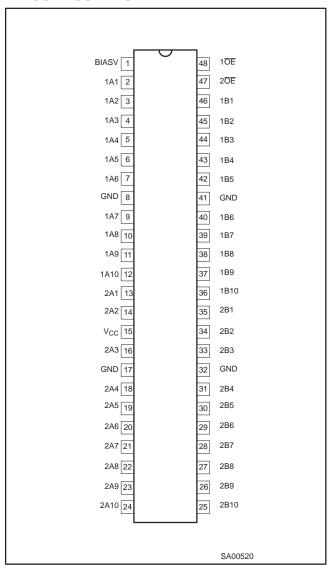
DESCRIPTION

The CBT6820 provides twenty bits of high-speed TTL-compatible bus switching. The low on-state resistance of the switch allows bi-directional connections to be made while adding near-zero propagation delay. The device also precharges the B port to a user-selectable bias voltage (BIASV) to minimize live-insertion noise.

The device is organized as two 10-bit switch with individual enable (OE) input. When OE is low, the switch is on and port A is connected to port B. When OE is high, the switch between port A and port B is open and the B port is precharged to BIASV through the equivalent of a 10 $k\Omega$ resistor.

Special clamp circuitry and Schottky diode clamps to ground are used to prevent an under voltage on the A side (Vin < GND) from causing the B side precharge voltage to drop below the "1" state.

PIN CONFIGURATION



QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} /t _{PHL}	Propagation delay An to Bn or Bn to An	$C_L = 50 \text{ pF}, V_{CC} = 5 \text{ V}$	0.25	ns
C _{IN}	Input capacitance		4.5	pF
C _{I/O}	Input/output capacitance	Outputs disabled; V _O = 0 V or V _{CC}	9.5	pF

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	ORDER CODE	DWG NUMBER
48-Pin Plastic TSSOP Type II	-40°C to +85°C	CBT6820 DGG	SOT362-1

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PIN DESCRIPTION

PIN NUMBER	SYMBOL	NAME AND FUNCTION
1	BIASV	Precharge bias voltage input
2, 3, 4, 5, 6, 7, 9, 10, 11,12	1A1-1A10	Port 1A1 to Port 1A10
8, 17, 32, 41	GND	Ground (V)
13, 14, 16, 18, 19, 20, 21, 22, 23, 24	2A1-2A10	Port 2A1 to Port 2A10
15	V _{CC}	Positive supply voltage
35, 34, 33, 31, 30, 29, 28, 27, 26, 25	2B1-2B10	Port 2B1 to Port 2B10
46, 45, 44, 43, 42, 40, 39, 38, 37, 36	1B1-1B10	Port 1B1 to Port 1B10
48, 47	10E, 20E	Switch enables

FUNCTION TABLE

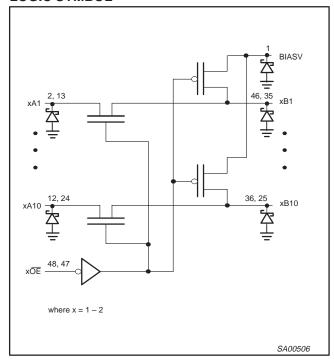
ŌĒ	STATE
L	A Port = B Port
Н	A Port = Z
Н	B Port = BIASV

H = High voltage level

L = Low voltage level

Z = High impedance "off" state

LOGIC SYMBOL



ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC clamp diode current	V _I < 0	-50	mA
VI	DC input voltage ¹		-0.5 to +7.0	V
I _{SW}	DC continuous channel current	$V_O = 0$ to V_{CC}	±128	mA
V _{BIASV}	DC bias voltage		-0.5 to +7.0	V
T _{stg}	Storage temperature range		-65 to 150	°C
øJA	Plastic thin shrink small outline package (TSSOP)		104	°C/W

NOTE

RECOMMENDED OPERATING CONDITIONS

CVMDOL	DADAMETED	LIM		
SYMBOL	PARAMETER	Min	Max	UNIT
V _{CC}	DC supply voltage	4.0	5.5	V
BIASV	DC supply voltage	1.3	V _{CC}	V
V _{IH}	High-level input voltage (control pin)	2.0		V
V _{IL}	Low-level Input voltage (control pin)		0.8	V
T _{amb}	Operating free-air temperature range	-40	+85	°C

^{1.} The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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DC ELECTRICAL CHARACTERISTICS

				UNIT		
SYMBOL	PARAMETER	TEST CONDITIONS	T _{am}			
			Min	Typ ¹	Max	1
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_I = -18mA$			-1.2	V
II	Input leakage current (control pin)	V _{CC} = 5.5V; V _I = GND or 5.5V			±5	μΑ
ΙO	Output bias current (B pins)	$V_{CC} = 4.5V$; BiasV = 2.4V; $V_O = 0$, $\overline{OE} = V_{CC}$			-0.25	mA
I _{CC}	Quiescent supply current	$V_{CC} = 5.5V; I_{O} = 0, V_{I} = V_{CC} \text{ or GND}$			2.5	mA
Δl _{CC}	Control pins ²	V_{CC} = 5.5V, one input at 3.4V, other inputs at V_{CC} or GND			2.5	mA
C _I	Input capacitance per OE pin	V _I = 3V or 0		4.5		pF
C _{O(OFF)}	Capacitance per port (OFF-state)	V _O = 3V or 0; switch off		9.5		pF
		V _{CC} = 4.5V; V _I = 0V; I _I = 64mA		5	7	
r _{on} 3	On-resistance	V _{CC} = 4.5V; V _I = 0V; I _I = 30mA		5	7	Ω
		V _{CC} = 4.5V; V _I = 2.4V; I _I = -15mA		10	15	1
V _P	Pass voltage	$V_{IN} = V_{CC} = 4.5V; I_{out} = -100\mu A$	3.4	3.6	3.9	V
I _{USP}	Undershoot static current protection ⁴	$\begin{aligned} &V_{CC} = 5.0 \text{V}, \ V_{Bias} = V_{CC} \\ &I_B = -5 \mu \text{A}, \ V_B \geq 3.0 \text{V} \end{aligned}$	-10			mA

- All typical values are at VCC = 5V, TA = 25 C
 This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND
 Measured by the voltage drop between the A and the B terminals at the indicated current through the switch. On–state resistance is determined by the lowest voltage of the two (A or B) terminals.

4. Force I_{USP} , measure $V_B \ge 3V$

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AC CHARACTERISTICS FOR V_{CC} = 5.0V \pm 0.5V RANGE

GND = 0V; $t_r = t_f \le 2.5 \text{ns}$; $C_L = 50 \text{pF}$.

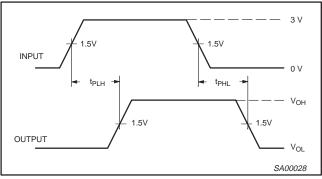
SYMBOL	PARAMETER	WAVEFORM	T _{aml}	UNIT		
			MIN	TYP ¹	MAX	
t _{pd}	Propagation delay; An to Bn; Bn to An ²	1			0.25	ns
t _{PZH}	3-State output enable time OE to An; OE to Bn; BIASV = GND	2	1.3	3.1	5.3	ns
t _{PZL}	3-State output enable time OE to An; OE to Bn; BIASV = 3.0V	2	1.4	2.9	4.6	ns
t _{PHZ}	3-State output enable time OE to An; OE to Bn; BIASV = GND	2	1.7	2.8	4.5	ns
t _{PLZ}	3-State output enable time \overline{OE} to An; \overline{OE} to Bn; BIASV = 3.0V	2	2.8	4.4	6.6	ns

NOTE:

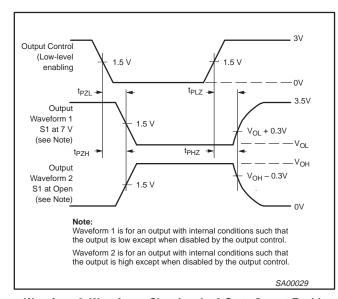
- 1. All typical values are measured at $T_{amb} = 25^{\circ}C$ and $V_{CC} = 5.0V$ 2. Warranted but not production tested. The propagation delay is based on the RC time constant of the typical ON-state resistance of the switch and a load capacitance of 50pF, when driven by an ideal voltage source (zero output impedance)

AC WAVEFORMS

 $V_{M} = 1.5V, V_{IN} = GND \text{ to } 3.0V$

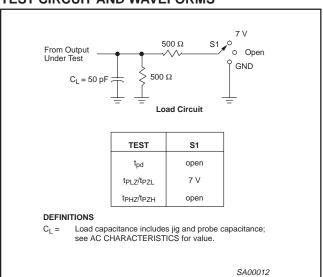


Waveform 1. Waveforms Showing the Input (An) to Output (Bn) **Propagation Delays**



Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

TEST CIRCUIT AND WAVEFORMS



NOTES:

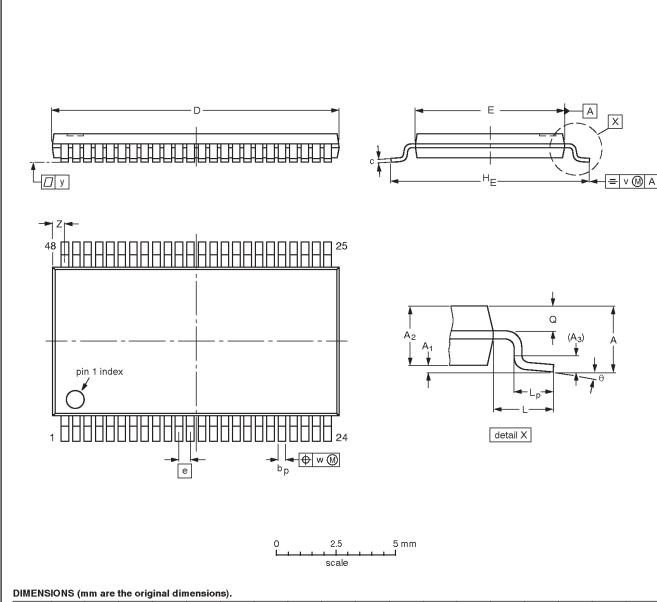
- All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , $t_r \leq$ 2.5 ns, $t_f \leq$ 2.5 ns.
- The outputs are measured one at a time with one transition per measurement

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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



UNIT	A max.	A ₁	A ₂	А3	bp	С	D ⁽¹⁾	E ⁽²⁾	е	HE	L	Lp	Q	v	w	у	z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

Notes

- 1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
- 2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	ENCES		EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT362-1		MO-153ED				-93-02-03 95-02-10

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NOTES

2000 Jun 19 7

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Data sheet status

Data sheet status	Product status	Definition [1]				
Objective Development specification		This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.				
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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